MODEL NO. : _	TM043NBH01
SSUED DATE: _	2010-12-10
VERSION ·	Var 1 4

■ Preliminary Specification ☐ Final Product Specification

Customer :	MITAC	
Approved by		Notes

SHANGHAI TIANMA Confirmed:

Prepared by	Checked by	Approved by

This technical specification is subjected to change without notice



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Record of Revision

Rev	Issued Date	Description	Editor
1.0	2010-07-09	-	Kelly.hu
1.1	2010-11-24	1.Update the 45th pin definition to ID PIN in Input/Output Terminals and ME drawing 2.Updated RA conditions 3.Added Mechanical Design Guide	Kelly.hu
1.2	2010-11-24	Updated the pin definition	Kelly.hu
1.3	2010-12-25	Updated power sequence	Kelly.hu
1.4	2010-10-10	Revised Data Input Timing Diagram Added Power on/off timing parameter	Kelly.hu



1 General Specifications

	Feature	Spec		
	Size	4.3 inch		
	Resolution	480(RGB)x272		
	Interface	RGB 24 bits		
	Color Depth	16.7M		
Display Spec.	Technology Type	a-Si		
Display Spec.	Pixel Configuration	R.G.B Vertical Stripe		
	Display Mode	TN,NW		
	Surface Treatment	AG		
	Viewing Direction	6 o'clock		
	Gray Scale Inversion Direction	12 o'clock		
	LCM (W x H x D) (mm)	105.50x67.20x4.15		
Mechanical Mechanical	Active Area(mm)	95.04x53.856		
Characteristics	With /Without TSP	With TSP		
2.14.40.0.10.100	Weight (g)	TBD		
	LED Numbers	10 LEDs		

Note 1: Viewing direction for best image quality is different from TFT definition. There is a 180 degree shift.

Note 2: Requirements on Environmental Protection: Q/S0002

Note 3: LCM weight tolerance: ± 5%

2 Input/Output Terminals

2.1 TFT LCD Panel

NO	Symbol	I/O	Description	Comment
1	VSS	Р	Ground	
2	VSS	Р	Ground	
3	VDD	Р	Power supply	
4	VDD	Р	Power supply	
5	R0	I	Data input	
6	R1	I	Data input	
7	R2	I	Data input	
8	R3	I	Data input	
9	R4	I	Data input	
10	R5	I	Data input	
11	R6	I	Data input	
12	R7	I	Data input	
13	G0	I	Data input	
14	G1	I	Data input	
15	G2	I	Data input	
16	G3	I	Data input	
17	G4	I	Data input	
18	G5	I	Data input	
19	G6	I	Data input	
20	G7	I	Data input	
21	B0	I	Data input	
21 22	B1	I	Data input	
23	B2	I	Data input	
24	B3	I	Data input	
25	B4	I	Data input	
26	B5	I	Data input	
26 27	B6	I	Data input	
28	B7	I	Data input	
29	VSS	Р	Ground	
30	PCLK	ı	Clock for input data. Data is latched at falling edge of this signal.	е
31	PON	I	Standby mode. PON ="1": Normally operation. PON ="0": Standby mode.	
32	HSYNC	I	Horizontal sync input with negative polarity. unused, please pull high level.	f
33	VSYNC	I	Vertical sync input with negative polarity. If unused please pull high level.	,
34	DE	I	Data input enable. If unused, please pull low level.	
35	PWRSEL		No connection	
36	VSS	Р	Ground	
37	Y2		YU	
38	X2		XL	



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39	Y1		YD
40	X1		XR
41	VSS	Р	Ground
42	LED1-	Р	Back light cathode
43	LED1+	Р	Back light anode
44	NC		No connection
45	ID	0	GND level



Absolute Maximum Ratings

3.1 Driving TFT LCD Panel

Ta =25°C

Item	Symbol	MIN	MAX	Unit	Remark
Supply Voltage	VDD	-0.3	4.0	V	
Back Light Forward Current	I _{LED}		25	mA	For each LED
Operating Temperature	T_OPR	-10	60	$^{\circ}$	
Storage Temperature	T_{STG}	-40	75	$^{\circ}$	

4 Electrical Characteristics

4.1 Driving TFT LCD Panel

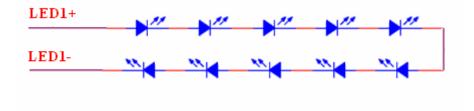
GND=0V, Ta=25℃

Item		Symbol	MIN	TYP	MAX	Unit	Remark
Supply V	oltage	VDD	3.0	3.3	3.6	V	
Input Signal	Low Level	V_{IL}	0	I	0.3xVDD	V	
Voltage	High Level	V _{IH}	0.7xVDD		VDD	V	
Output Signal	Low Level	V_{OL}		1	0.2xVDD	V	
Voltage	High Level	V_{OH}	0.8xVDD	-	VDD	V	
(Panel+LSI)		Black Mode (60Hz)		TBD		mW	
Power Consu	mption	Standby Mode		TBD		mW	

4.2 Backlight Unit

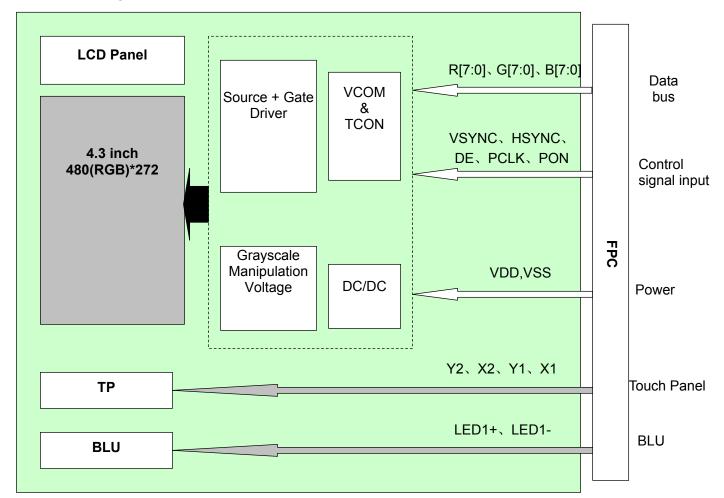
Ta=25℃

Item	Symbol	MIN	TYP	MAX	Unit	Remark
Forward Current	I _F		22	25	mA	
Forward Current Voltage	V _F		32		V	
Backlight Power Consumption	W_{BL}	1	704	1	mW	



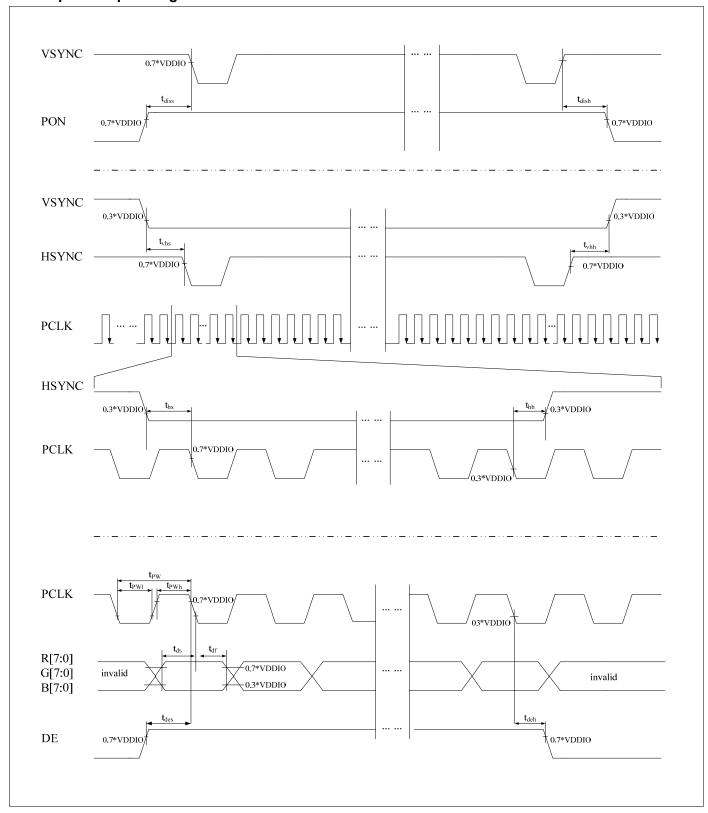
4.3 Block Diagram

LCD module diagram



5 Timing Chart

5.1 Input Setup Timing



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5.2 Input Setup Timing Parameter Setting

VDD=3.3V Ta=25℃

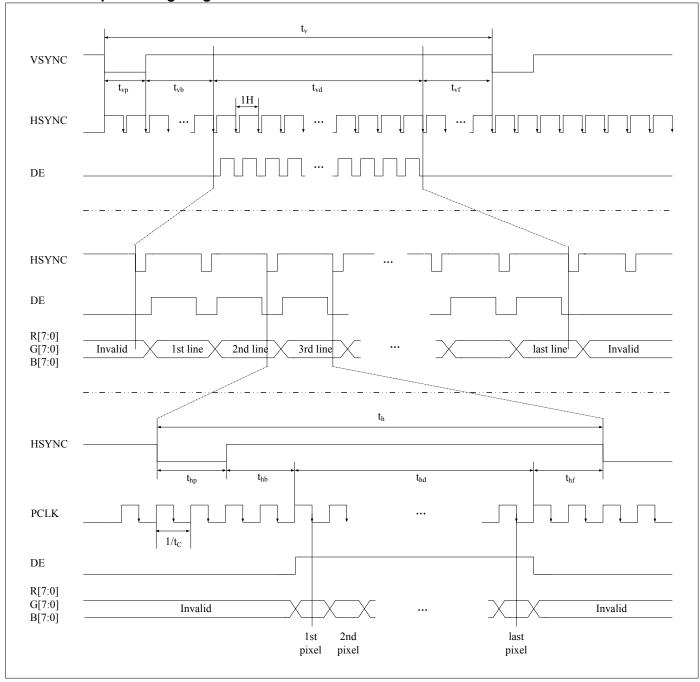
Parameter	Symbol	Min	Тур	Max	Unit	Remark
DCLK Cycle Time	T_pw	66.7	-	-	ns	
DCLK Pulse High Width	T_pwh	26.7	-	ı	ns	
DCLK Pulse Low Width	T_pwl	26.7	ı	ı	ns	
DE Setup Time	T_{des}	10	-	-	ns	
DE Hold Time	T_{deh}	10	-	-	ns	
HSYNC Setup Time	T_{hs}	10	-	ı	ns	
HSYNC Hold Time	T_{hh}	10	ı	ı	ns	
VSYNC Setup Time	T_{vhs}	10	-	-	ns	
VSYNC Hold Time	T_{vhh}	10	-	ı	ns	
Data Setup Time	T_{ds}	10	-	-	ns	
Data Hold Time	T_{dh}	10	-	-	ns	
DISP Setup Time	T_{diss}	10	-	-	us	
DISP Hold Time	T_{dish}	10	-	-	ms	

Note 1: $t_r=t_f=2ns.t_r$, t_f is defined 10% to 90% of signal amplitude.

Note 2: For parallel interface, maximum clock frequency is 15MHz.

5.3 Data Input Format

5.3.1 Data Input Timing Diagram



Note 1: When DE is pulled low, Sync mode is active using HSYNC+ VSYNC for timing control. Note 2: When DE is pulled high for active data and pulled low for blanking data, DE mode is active for timing control.



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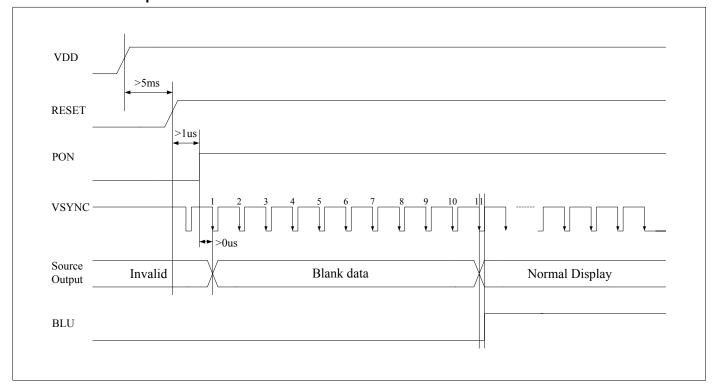
5.4 Data Input Timing Parameter Setting

Parameter	Symbol		Spec.		Unit
raiameter	Syllibol	Min.	Тур.	Max.	Offic
DCLK frequency	f _{clk}	-	9	15	MHZ
HSYNC frequency	1/t _h	-	17.14	-	KHz
VSYNC frequency	$1/t_{v}$	-	59.94	-	Hz
Horizontal cycle	t _h	525	525	605	DCLK
Horizontal display period	t _{hd}	480		DCLK	
Horizontal pulse width	t_{hp}	2	41	41	DCLK
Horizontal back porch	t_hb	2	2	41	DCLK
Horizontal front porch	t _{hf}	2	2	82	DCLK
Vertical cycle	t _v	285	286	399	HSYNC
Vertical display period	t _{vd}	272		HSYNC	
Vertical pulse width	t _{vp}	1	10	11	HSYNC
Vertical back porch	t _{vb}	1	2	11	HSYNC
Vertical front porch	t _{vf}	1	2	227	HSYNC

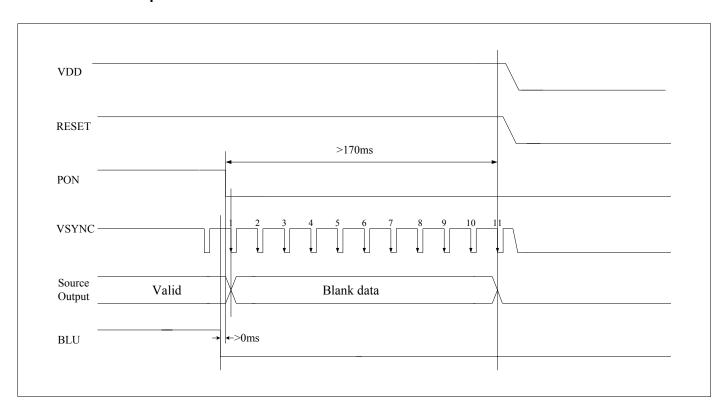
Note 1: Unit: CLK=1/ f_{CLK}, H= t_h,

Note 2: It is necessary to keep $t_{vp}+t_{vb}=12$ and $t_{hp}+t_{hb}=43$ in sync mode. DE mode is unnecessary to keep it.

5.5 Power ON Sequence



5.6 Power Off Sequence



6 Optical Characteristics

Ta=25°C

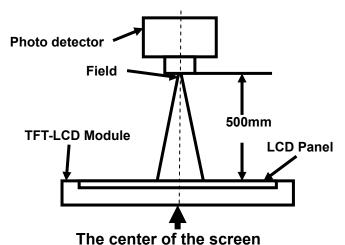
Item		Symbol	Condition	Min	Тур	Max	Unit	Remark
M A		θТ	- CR≧10	60	70	-	Dograd	Note 2.2
		θВ		40	50	ı		
View Angles		θL	ON = 10	60	70	-	Degree	Note2,3
		θR		60	70	-		
Contrast Ratio)	CR	θ=0°	400	450	ı		Note 3
Pasnonsa Tim	Δ.	T _{ON}	25 ℃		20	30	ma	Note 4
Response Time		T _{OFF}	25 C	-	20	30	ms	Note 4
	White	x	Backlight is on	0.270	0.320	0.370		Note 1,5
		у		0.290	0.340	0.390		
	Red	x		0.531	0.581	0.631		Note 1,5
Chromaticity		У		0.295	0.345	0.395		
Omomaticity	Green	x		0.298	0.348	0.398		Note 1,5
	Green	у		0.531	0.581	0.631		
	Blue	x		0.103	0.153	0.203		Note 1,5
		у		0.045	0.095	0.145		Note 1,5
Uniformity		U			80	-	%	Note 6
NTSC				-	50	ı	%	Note 5
Luminance		L		300	400	-	cd/m ²	Note 7

Test Conditions:

- 1. I_F = 22 mA, and the ambient temperature is 25 °C.
- 2. The test systems refer to Note 1 and Note 2.

Note 1: Definition of optical measurement system.

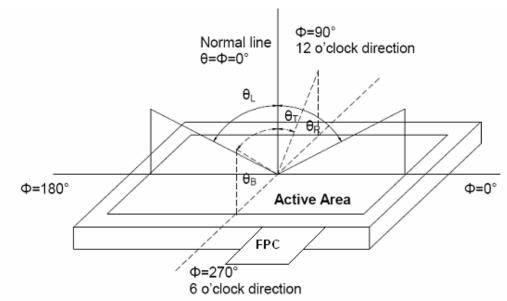
The optical characteristics should be measured in dark room. After 5 Minutes operation, the optical properties are measured at the center point of the LCD screen. All input terminals LCD panel must be ground when measuring the center area of the panel.



Item	Photo detector	Field	
Contrast Ratio			
Luminance	SR-3A	1°	
Chromaticity	SK-SA	ı	
Lum Uniformity			
Response Time	BM-7A	2°	

Note 2: Definition of viewing angle range and measurement system.

viewing angle is measured at the center point of the LCD by CONOSCOPE(ergo-80).



Note 3: Definition of contrast ratio

Contrast ratio (CR) = $\frac{\text{Luminance measured when LCD is on the "White" state}}{\text{Luminance measured when LCD is on the "Black" state}}$

"White state ": The state is that the LCD should drive by Vwhite.

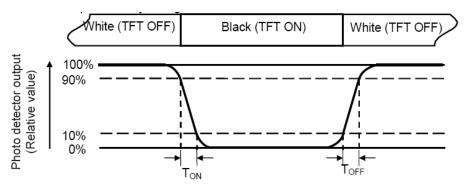
"Black state": The state is that the LCD should drive by Vblack.

Vwhite: To be determined Vblack: To be determined.

Note 4: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and

"Black" state. Rise time (T_{ON}) is the time between photo detector output intensity changed from 90% to 10%. And fall time (T_{OFF}) is the time between photo detector output intensity changed from 10% to 90%.



Note 5: Definition of color chromaticity (CIE1931)

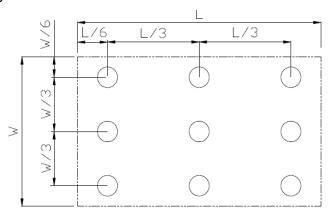
Color coordinates measured at center point of LCD.

Note 6: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer Fig. 2). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (U) = Lmin/Lmax

L----- Active area length W---- Active area width



Lmax: The measured Maximum luminance of all measurement position.

Lmin: The measured Minimum luminance of all measurement position.

Note 7: Definition of Luminance:

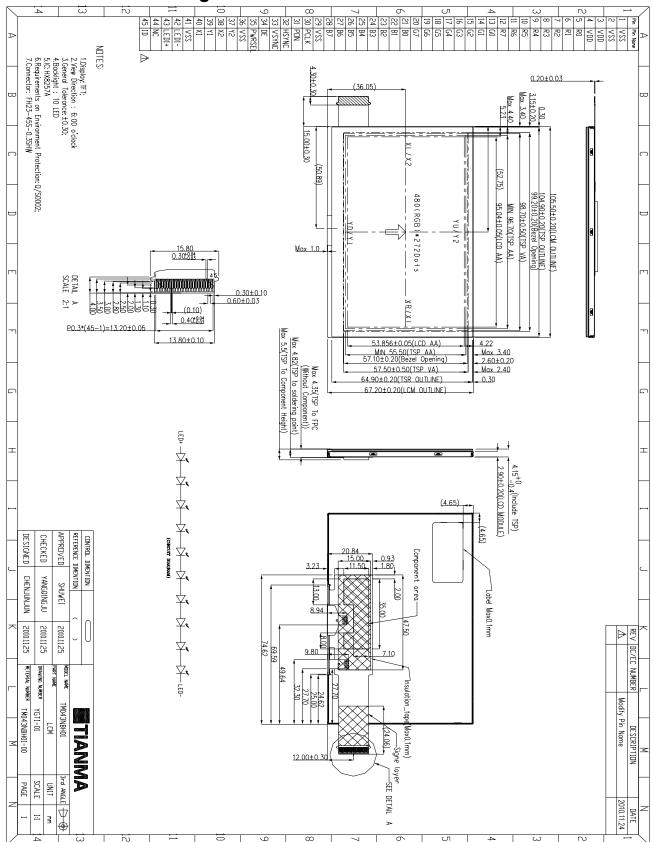
Measure the luminance of white state at center point.

Environmental / Reliability Test

Test Item	Test Condition	Remark
Operating temp./Humi	Spec.Temp:-10~+60°C (cycles) Humidity:10~90%(R.H)Temp	
Storage	Spec.Temp:-40~+75℃ (cycles) Humidity:10~90%(R.H)Temp	
Low/High temperature kick off display quality performance test	1.Single panel with demo kit or system. 2.Cold start and pattern switch on LCD display. 3.Single panel with Demo Kit or system put into Low/high environment. (Non-operation).During cold boot check the LCD display pattern is exist any flicker(閃爍),drag(拖尾),shake(抖動),Blur(模糊),line(線條),cascade(瀑布狀 clock/frequency issue),bright /black dots(亮/暗點).Newton ring(牛頓環)etc the abnormal display on LCD screen. 4. Test procedure: 4-1.specimens soaks in each temperature at least 2 hours. 4-2.Cold start (kick off) into idle screen and each pattern shall switch to check the screen is stable under display and power off (or shutdown). The process finish it, we call one cycle. Before next cycle starting the period shall wait for 5 minutes. 4-3.Test temperature range - 10°C,0°C,10°C,50°C,60°C. Each temperature range has 5 cycles for test. 4-4.All abnormal phenomenon shall record	
Thermal shock A	Type A Operation temp:-10 ℃ to+60 ℃, change specification:15 ℃/min at least 1hour after stabilization for 10 cycles	
Thermal shock B	Type B Non-operation temp:-40°C to+75°C, change specification:15°C/min at least 1hour after stabilization for 10 cycles	
Shock	60G 6ms,±X,±Y,±Z 3times for each direction	
ESD	Contact:±4KV,Air:±8KV,150pF/330 Ω	



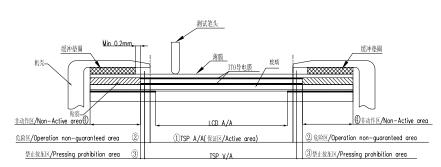
8 Mechanical Drawing



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Mechanical Design Guide

结构注意事项



①区域:动作区此区域按压时触摸屏正常工作。

按压此区域触摸屏不能正常工作,若对此区域做打点、划线测试,将损坏产品,导致产品寿命下降,此区域大约是动作区外侧0.5~1mm。

③区域:禁止按压区 按压此区域会严重损伤内部导电层,使触摸屏的功能严重破坏。

④区域: 非动作区 按压此区域触摸屏不工作。

2、敏感区的处理:

(1)区域②、③为敏感区,由于该区域在产品上下导电面之间存在间隙,按压此处时ITO导电膜受压产生较大变形,引起ITO导电膜断裂,从而使触摸屏丧 失功能。故使用触摸屏产品时,一定要充分考虑敏感区的尺寸及外壳的构造,必须避免最终的用户使用时触及到此区域。

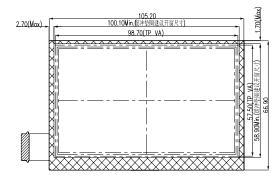
(2) 组装触摸屏时,必须在产品表面四周加上一缓冲垫圈,再装外壳。垫圈应落在双面胶上,且不能超出双面胶范围。

(3) 若外壳设计比动作区大时,最终用户有可能触及到敏感区而损伤产品。

保持在0.2~0.3mm之间。

建议尺寸



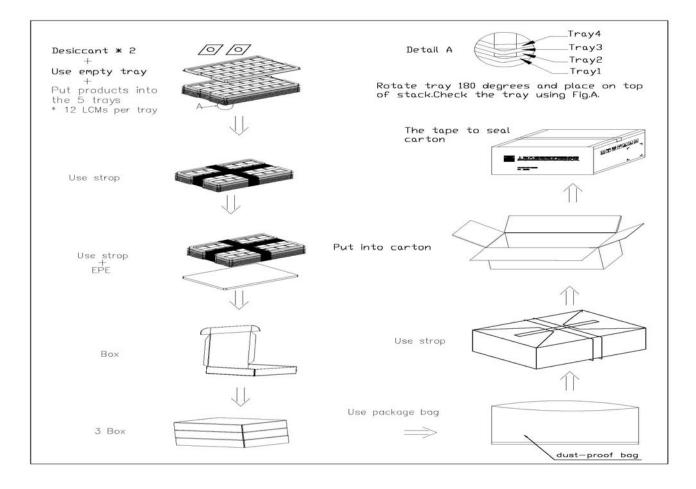




SHANGHAI TIANMA MICRO-ELECTRONICS

9 Packing Drawing

				Unit Weight		
No	Item	Model (Material)	Dimensions(mm)	(Kg)	Quantity	Remark
1	LCM module	TM043NBH01	105.50x67.20x4.15	TBD	180	
2	Tray	PET (Transmit)	485x330x14.8mm	TBD	18	
3	EPE	EPE	485x330x5	0.08	3	
4	Anti-static bag	PE	700x545mm	0.046	1	
5	вох	Corrugated Paper	520x345x74	0.44	3	
6	Desiccant	Desiccant	45x50	0.002	6	
7	Carton	Corrugated Paper	544x365x250	1.01	1	
8	Total weight	TBD Kg				



10 TFT- LCD Module Incoming Inspection Standard

10.1 Scope

The incoming inspection standards shall be applied to TFT-LCD Modules (hereinafter called "Modules") that supplied by Shanghai Tianma Micro-Electronics Corporation.

10.2 Incoming Inspection

The customer shall inspect the modules within twenty calendar days of the delivery date(the "inspection period)at its own cost. The result of the inspection(acceptance or rejection)shall be recorded in writing, and a copy of this writing will be promptly sent to the seller, If the results of the inspecting from buyer does not send to the seller within twenty calendar days of the delivery date. The modules shall be regards as acceptance.

Should the customer fail to notify the seller within the inspection period, the buyer's right to reject the modules. Shall be lapsed and the modules shall be deemed to have been accepted by the buyer.

10.3 Inspection Sampling Method

Lot size: Quantity per shipment lot per model

Sampling type: Normal inspection, Single sampling

Inspection level: II

Sampling table: MIL-STD-105D Acceptable quality level (AQL) Major defect: AQL=0.65 Minor defect: AQL=1.00

10.4 Inspection Conditions

10.4.1 ambient conditions:

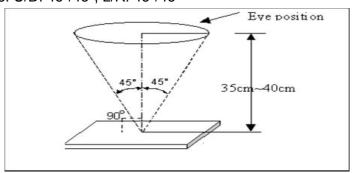
a. Temperature: Room temperature 25±5℃

b. Humidity: (60±10) %RH

c. Illumination: Single fluorescent lamp non-directive (1000 to 1200 Lux)

10.4.2 The viewing distance between the LCD and the inspector's eyes shall be at least 30±5 cm.

10.4.3 Viewing Angle: U/D: 45°/45°, L/R: 45°/45°



10.5 Inspection Criteria

Defects are classified as major defects and minor defects according to the degree of defectiveness defined herein.

Major defect

Item	Inspection Standard	
All Functional Defects	1) No display 2) Display abnormally 3) Short circuit 4) line defect	
Missing	Missing function component	
Crack	Glass Crack	

Minor defect

No No	Item	Inspection Standard		
	Spot Defect (Including	$\varphi = (\mathbf{x} + \mathbf{y}) / 2$ $\longrightarrow \mathbf{X} \qquad \qquad$		
1		Size φ(mm)	Acceptable Quantity	
'	black spot and white spot)	φ≤0.20	Ignore	
	winte spot)	0.20<φ≤0.30	2	
		0.30<φ≤0.40	1	
		0.40<φ	Not allowed	
	Line Defect (Including black line, white line and scratch)	Length Width Define:		
2		Width(mm) Length(mm)	Acceptable Quantity	
		W≤0.03	Ignore	
		0.03 <w≤0.1 0.8<l≤2.0<="" td=""><td>2</td></w≤0.1>	2	
		0.1 <w l="" or="">2.0</w>	Not allowed	
	Polarizer Dent/Bubble	Sizeφ(mm)	Acceptable Quantity	
3		φ≤0.1	Ignore	
		0.1<Φ≤0.3	2	
		0.3<φ	0	

		Bright and black dot define:		
Δ Electrical Dot	克點 ■ and			
4	4 Defect	Inspection pattern: Full white, Full black, Red, green and blackers		
		Item	Acceptable Quantity	
		Black dot defect	2	
		Bright dot defect	1	
		Total Dot	2	
5	Nowton Bing	Sizeφ(mm)	Acceptable Quantity	
3	Newton Ring	D <15mm	1	

Note1: Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

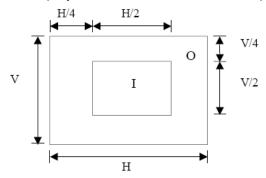
Note2: The distance between two bright dot defects (red, green, blue, and white) should be larger than 10mm.

Note3: The distance between black dot defects or black and bright dot defects should be more than 5mm apart.

Note4: The definitions of the inner display area and outer display area

I: Inner display area

O: Outer display area



Note5: Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

10.6 Mechanics specification

As for the outside dimension, weight of the modules, please refer to product specification for more details

11 Precautions for Use of LCD Modules

11.1 Handling Precautions

- 11.1.1 The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- 11.1.2 If the display panel is damaged and the liquid crystal substance inside it leaks out, be sure not to get any in your mouth, if the substance comes into contact with your skin or clothes, promptly wash it off using soap and water.
- 11.1.3 Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- 11.1.4 The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- 11.1.5 If the display surface is contaMinated, breathe on the surface and gently wipe it with a soft dry cloth. If still not completely clear, moisten cloth with one of the following solvents:
 - Isopropyl alcohol
 - Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 11.1.6 Do not attempt to disassemble the LCD Module.
- 11.1.7 If the logic circuit power is off, do not apply the input signals.
- 11.1.8 To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
 - 10.1.8.1 Be sure to ground the body when handling the LCD Modules.
 - 10.1.8.2 Tools required for assembly, such as soldering irons, must be properly ground.
- 10.1.8.3 To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
- 10.1.8.4 The LCD Module is coated with a film to protect the display surface. Be care when peeling off this protective film since static electricity may be generated.

11.2 Storage precautions

- 11.2.1 When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps.
- 11.2.2 The LCD modules should be stored under the storage temperature range. If the LCD modules will be stored for a long time, the recommend condition is:

Temperature : 0°C ~ 40°C Relatively humidity: ≤80%

11.2.3 The LCD modules should be stored in the room without acid, alkali and harmful gas.

11.3 Transportation Precautions

11.3.1 The LCD modules should be no falling and violent shocking during transportation, and also should avoid excessive press, water, damp and sunshine.